

Low Pressure Chemical Vapor Deposition of TiO₂ Layer in Hydrogen-Ambient

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Abstract

Low pressure chemical vapor deposition (LPCVD) of anatase TiO₂ layer using metalorganic precursor of titanium-tetra-iso-propoxide (TTIP) and H₂ as a reduction gas was demonstrated at pressure of 3 mtorr in comparison to that using TTIP and O₂ with study for the property of the layers. Dissociation energy of TTIP in H₂ was higher than that in O₂ but resistivity of the layer deposited in H₂ was significantly decreased to 0.2 Ω cm in contrast to the high resistivity beyond 100 Ω cm of the layer deposited in O₂. UV-Vis optical transmission spectra showed absorption around 2.2 eV was increased in the layer deposited by TTIP + H₂ in addition to decrease of forbidden energy gap due to increase of Urbach tail. Resistivity at low temperature below 100 K indicating the layer deposited in H₂-ambient was degenerated by the high electron density but the resistivity was decreased with temperature above 100 K with the activation energy about 100 meV. A possible electronic conduction model based on kernel, grain boundary and surface trap to clarify the temperature dependent resistivity suggesting resistivity of the layer was limited by depletion region in the grain-boundary extended from the surface and the kernel with significantly low resistivity in 10⁻³ Ω cm order was formed in the layer.

Keywords

LPCVD, TTIP+H₂, Anatase-TiO₂, Low Resistive TiO₂

1. Introduction

TiO₂ has been extensively investigated in view of photo-induced applications using the photo-catalytic reactions and the hydrophilicity [1] [2] in addition to dielectric applications using the high dielectric constant and optoelectronic applications by the high refractive index [3] [4]. On the other hand, the material has been also expected

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for transparent conduction oxide (TCO) because of the wide band gap of 3.2 eV. In addition, the conductive TiO₂ with significantly high resistance in acid and alkaline solutions has interesting potentials to fabricate solar-cells, chemical sensors etc. However, it is easily recognized that the conductivity control is more difficult than the other TCO such as ITO, Sn₂O and ZnO since d-orbital contributes to forming TiO₂. Recently, laser-ablation and reactive sputtering with the post-annealing in reduction ambient have been applied to form highly conductive TiO₂ layer by using Nb as a donor-dopant [5] [6]. In such process, oxygen-deficiency is seemed to be required to enhance the electronic activation of the donor [7], in which Ti³⁺ reduced from Ti⁴⁺ probably plays an important role of the conduction in TiO₂. On the other hand, chemical vapor deposition (CVD) which is able to form thin film with step coverage better than that by physical vapor deposition has been studied on TiO₂ fabrication. In the CVD process, suitable primary-source is fundamentally required in addition to control of the deposition condition. It has been well recognized that titanium-tetra-iso-propoxide (TTIP: Ti(O-i-C₃H₇)₄) is a suitable metalorganic precursor for the TiO₂ deposition and the thermally dissociated species is crystallized in the anatase-phase around 400°C [8]. However, few studies have been reported for the conductivity control of TiO₂ layer by CVD. Also in the CVD process, it can be believed that Ti³⁺ in TiO₂ layer plays an important role for the conductivity. Previously, we demonstrated low pressure chemical vapor deposition (LPCVD) of TiO₂ layer using TTIP + O₂ and Nb-F co-doping by using the dopant of NbF₅, in which the resistivity was decreased to 0.2 Ω cm by the doping in contrast to high resistivity of the undoped layer beyond 100 Ω cm [9]. Further, XPS study showed that F substituted to the O-site contributes to the reduction of resistivity, which can be recognized; the F reduced Ti⁴⁺ to Ti³⁺ and Ti³⁺ supports the activation of Nb-donor, but oxygen-vacancy increases the resistivity. These results are qualitatively in agreement with the results of molecular orbital calculations [9], in which the donor level due to 6-fold-coordinated Ti³⁺ is shallower than that of Ti³⁺ associated with oxygen-vacancy. These results indicate that Ti³⁺ ions or the complex defects are essentially required to control in the density and the nature for increase of the conductivity.

In this paper, LPCVD of TiO₂ layer using TTIP and reduction gas of H₂ is demonstrated to increase Ti³⁺ density and control the conductivity. The deposited layer is characterized by X-ray diffraction, UV-Vis transparent spectroscopy and the temperature dependent resistivity.

2. Experimental

2.1. LPCVD of TiO₂ Layer

A bell-jar type reactor with the base pressure under 1×10^{-5} torr by a combination of diffusion pump and a rotary pump was used for LPCVD of titanium-oxide. Titanium tetra-iso-propoxide (TTIP, Ti(O-i-C₃H₇)₄: 99.7% purity) was used as source gas after purification in vacuum. Details of the apparatus configuration and the purification sequence of TTIP were already shown elsewhere [9]. High purity hydrogen gas (99.99999%) was simultaneously introduced into the reactor through an individual gas inlet during the deposition. In the case of the deposition in O₂, high purity oxygen gas (99.99999%) instead of H₂ was introduced into the reactor. The gas supply ratio of TTIP/H₂ or TTIP/O₂ were controlled by monitoring the reactor pressure using Shultz gage when TTIP and H₂ or O₂ were introduced into the reactor, in which sensitivity of the ion gage for H₂ and O₂ was taken into account to determine the gas supply ratio to TTIP. Substrate of 1 mm-thick quartz plate with optically flat surface was mounted on a substrate holder after chemical cleaning. Temperature of the substrate holder on resistive heater was monitored by K-type thermo-couple and controlled by PID-system.

2.2. Evaluation of LCVD-TiO₂ Layer

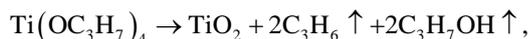
Thickness of the layer was checked by a surface profiler (Veeco, DEKTAK150). Resistivity was evaluated by Van Der Pauw (VDP) method using symmetric four ohmic contacts of Indium-dots, in which the temperature was varied from 10 to 300 K in vacuum and dark by a cryogenic system (Janis Research, CCS-150). Crystallographic behavior was examined by $\theta - 2\theta$ X-ray diffraction (RIGAKU: RAD-C) using CuK α . UV-Vis optical transmission spectra were obtained by UV-Vis spectrometer (OCEAN OPTICS: USB-2000) using a light source of Halogen lamp.

3. Results and Discussions

3.1. Deposition Rate and Resistivity of TiO₂ Layer

Figure 1(a) shows Arrhenius plot of TiO₂ deposition rate in O₂ (open-circle) and H₂ (solid-circle) ambient for

the deposition temperature, in which supply rate of the gas to TTIP was kept at 1. The deposition rate of the layer deposited in O₂ (TiO₂/O₂) and in H₂ (TiO₂/H₂) was increased with the temperature and then saturated above 360°C. At such low temperatures, the layers were poly-crystallized into anatase-phase as shown by XRD spectra in **Figure 1(b)**, in which the spectra of TiO₂/O₂ and TiO₂/H₂ deposited at 360°C is shown by black-line and red-line respectively. In the both spectra, diffraction peaks originated from (101) and (200) anatase-TiO₂ were observed but not any peaks due to another phase such as rutile and brookite. The diffraction peak intensities of the TiO₂/H₂ layer were weaker than that of the TiO₂/O₂ layer but the peak angle shift was not observed in the spectrum. Activation energy of 138 kJ/mol for the deposition of TiO₂/O₂ obtained the result in **Figure 1(a)** showed that TTIP-dissociation feature was scarcely influenced by O₂ because the energy was similar to CVD by TTIP single precursor [10]. In this case, it can be recognized TTIP is thermally dissociated then anatase-TiO₂ is formed with propene and isopropanol as follow reaction [11].



where it is expected Ti=O bonds are formed on the deposition surface [12]. Further, it is considered the surface Ti=O bonds act as adsorption-site of the precursor and enhance the dissociation of TTIP as depicted in **Figure 2(a)**. In contrast, the activation energy for TiO₂/H₂ was obtained as 230 kJ/mol. Previously, Shmakov *et al.* demonstrated quantum chemical calculations using B3LYP for monomolecular dissociation of TTIP and suggested

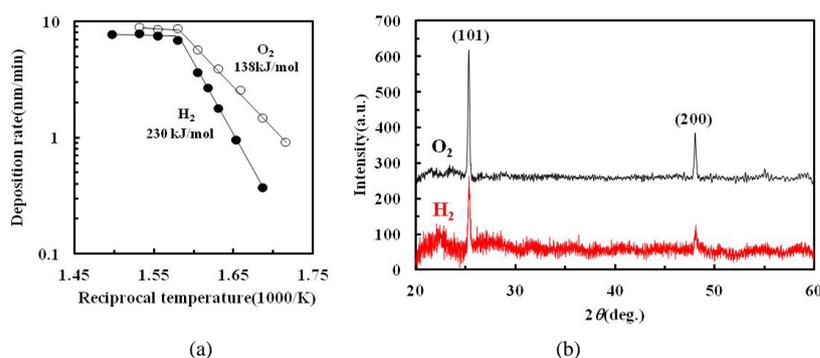


Figure 1. (a) Deposition rate in O₂ (open-circle) and H₂ (solid-circle) for the temperature and (b) typical $\theta - 2\theta$ XRD spectra of 200 nm-thick TiO₂ layer deposited at 360°C in O₂ (black-line) and H₂ (red-line), where the miller indicate shows anatase-TiO₂ surface.

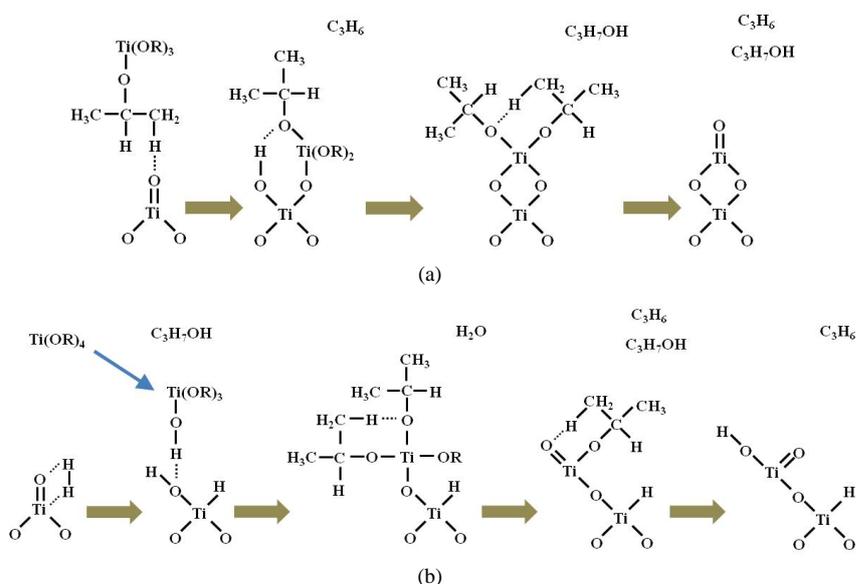


Figure 2. Expected scheme of TTIP-dissociation on deposition surface (a) without (b) with hydrogen contribution. Blue-bowline in (b) shows thermal dissociation of monomolecular TTIP.

the activation barrier to form $\text{Ti}(\text{OC}_3\text{H}_7)_3(\text{OH})$ and propene via O-H- CH_2 interaction in isopropyl group of TTIP is 56.9 kcal/mol (238 kJ/mol) [13]. The calculated value is in good agreement with the activation energy for the deposition TiO_2/H_2 , however, very high as compared to that for TiO_2/O_2 and the previous report using TTIP single precursor. It can be recognized the large different of the activation energy is owing to hydrogen at the deposition surface as shown in **Figure 2(b)**. When H_2 gas is simultaneously supplied with TTIP, methyl-group of TTIP cannot be allowed in the reaction to Ti-O or Ti on the deposition surface, because the surface consists of Ti=O is terminated by hydrogen. Therefore, the adsorption of the precursor is achieved after monomolecular dissociation to form $\text{Ti}(\text{OC}_3\text{H}_7)_3(\text{OH})$, then the adsorbed species is dissociated to TiO_x . It is noted Ti-H is probably remained in the deposited layer and the hydrogen is partially desorbed by thermal dissociation. In the scheme of the hydrogen-desorption, it is expected Ti^{4+} is reduced to Ti^{3+} and resulted in generation of donor-defect. **Figure 3** shows dependence of resistivity of TiO_2/H_2 on the deposition temperature, in which the layers were deposited with the thickness about 200 nm and the resistivity was evaluated by VDP method at room-temperature. Although all of TiO_2/O_2 layer was with high resistivity above 100 Ω cm beyond the evaluation limit of our system, resistivity of the TiO_2/H_2 layer deposited in H_2 was decreased with the deposition temperature and then gradually increased above 360°C. The activation energy of 244 kJ/mol obtained below 350°C suggested that donor concentration was increased with the temperature. Recently, it was reported that hydrogen acts as donor in TiO_2 by experimental results for anatase- TiO_2 powder (Degussa P25) treated by atomic-hydrogen [14] and molecular orbital theoretical results [15], in which hydrogen was found to be bound to lattice oxygen in TiO_2 . In this work, it is however considered that the donor species in the layer was not the hydrogen bound to O, because the absorption due to Ti-OH (Chemisorbed OH) which was identified in IR-spectrum of amorphous TiO_x layer deposited by plasma-assisted deposition at room-temperature [16] could not be observed in the TiO_2/H_2 layers. On the other, Nakamura *et al.* studied reduction treatment of anatase- TiO_2 powder by radio-frequency hydrogen-gas plasma at 400°C to enhance the visible light activity for NO removal [17]. In the report, ECR spectra indicated the anatase- TiO_2 is reduced by hydrogen excited in the plasma and oxygen-vacancies are formed with the double defect levels of 0.75 and 1.18 eV below the conduction band minimum. Although non-excited hydrogen gas was supplied below 380°C during the deposition in this work, it can be considered hydrogen was adsorbed to Ti as shown in **Figure 3** and maybe form oxygen-vacancies in the layer. However, the defect level is too deep to decrease the resistivity at room-temperature. Therefore, the defect to reduce the resistivity is not oxygen-vacancy but Ti^{3+} with the defect level shallower than the complex centers predicted by theoretical calculations [15]. Indeed, the activation energy of 244 kJ/mol obtained by the result in **Figure 3** was similar to the dissociation energy of 208 kJ/mol for Ti-H bond [18].

3.2. Optical Absorption

Figure 4 shows optical absorption spectra in UV-Vis region. Dot-lines in **Figure 4(a)** show transmission spectra of TiO_2/H_2 (red-line) and TiO_2/O_2 (black-line) layers grown at 360°C with the thickness about 200 nm. Gradual increase and relatively low value of optical transmittance in Vis-region suggested deep-level defects were included in the forbidden energy gap. The spectra were successfully deconvoluted into two-spectra with the peak at 2.2 eV and 3.0 eV, which were described by Gaussian-function, and near band edge absorption obtained after removal the two-spectra from the raw transmission spectrum. In **Figure 4(a)**, the deconvoluted spectra and

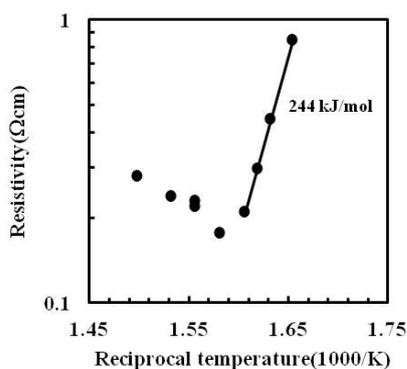


Figure 3. Resistivity of TiO_2/H_2 for the deposition temperature, in which the layers were deposited with thickness about 200 nm.

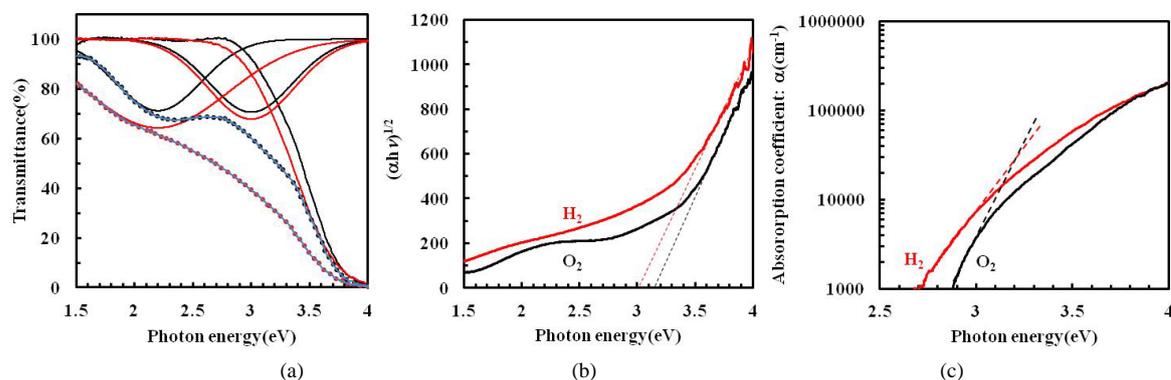


Figure 4. (a) Transmission spectra (dot-lines) and the deconvoluted spectra (solid-lines) with the fitting lines (blue-lines) of TiO₂/O₂ (black-lines) and TiO₂/H₂ (red-lines); (b) $(ah\nu)^{1/2}$ plots for photon energy with the linear relation line (dash-lines) to determine the optical band gap; and (c) absorption coefficient in near band edge region after removal the absorptions due to deep-levels centered at 2.2 eV and 3.0 eV.

the fitting curves are shown by solid-line (red-line: TiO₂/H₂, black-line: TiO₂/O₂) and blue-lines, respectively. Previously, Sekiya *et al.* suggested the origin of absorption at 3.0 eV and in between 2.2 and 2.3 eV, which were coincident to peak energies of the deconvoluted spectra in **Figure 4(a)**, is attributed to oxygen-vacancies with two-trapped electrons and electron transition of Ti³⁺ from ²T₂ to ²E state contributed by crystal field interaction with surrounding oxygen, respectively [19]. They also showed intensity of the absorption in between 2.2 and 2.3 eV is decreased by post-annealing above 300°C with decreasing electrical conductivity. In this work, the absorption peak at 2.2 eV was significantly increased in the intensity for TiO₂/H₂ whereas the absorption peak at 3.0 eV was scarcely different as compared with TiO₂/O₂. From these results, it is considered that increase of Ti³⁺ density in TiO₂/H₂ was independent from the increase of oxygen-vacancy and resulted in the reduction of resistivity. It is noted significant broadening of the absorption around 2.2 eV was also observed for the TiO₂/H₂ in comparison with TiO₂/O₂ as shown in **Figure 4(a)**, in which the full-width at half-maximum (FWHM) was 1.4 eV and 0.86 eV for the TiO₂/H₂ and TiO₂/O₂ respectively. The absorption broadening could be recognized crystal field around Ti³⁺ was more fluctuated in the layer as compared with the TiO₂/O₂, that is, structural disordering of TiO₂/H₂ was higher than that of TiO₂/O₂. Indeed, XRD spectra showed crystallinity of TiO₂/H₂ was inferior to that of TiO₂/O₂ as shown in **Figure 1(b)**. Further, it has been reported structural disordering causes band gap narrowing in crystal. **Figure 4(b)** shows Tauc plot in $(ah\nu)^{1/2}$ vs. photon energy ($h\nu$) to determine the optical band gap of TiO₂/H₂ (red-line) and TiO₂/O₂ (black-line), where α is absorption coefficient. The band gap of 3.16 eV given by the extrapolated linear line (black dot-line) for the TiO₂/O₂ was scarcely smaller than that of 3.2 eV for anatase-TiO₂. In contrast, the band gap was significantly reduced to 3.0 eV for the TiO₂/H₂. The estimated band gap of 3.0 eV was similar to that for rutile-TiO₂ but the lowering of band gap could be considered to be originated from defect states in the band gap, because any XRD diffraction peak corresponding to rutile phase could not be observed in the layer. On the other, it has been recognized localized defect states originated from structural disordering are extended form an optical absorption tail to lower energy side below the band gap and resulted in origin of the optical band gap narrowing, in which the tail is referred as Urbach tail represented by $\alpha = \alpha_0 \exp(h\nu/E_u)$ using Urbach energy (E_u) [20]. **Figure 4(c)** shows absorption coefficient of the TiO₂/H₂ (red-line) and TiO₂/O₂ (black-line) in log-scale against photon energy, where two-absorption spectra centered at 2.2 eV and 3.0 eV were numerically removed. Urbach energy obtained by the linear relationship in $\log(\alpha)$ vs. photon energy below band gap was 153 meV and 114 meV for the TiO₂/H₂ and TiO₂/O₂, respectively. Previously, Choudhury *et al.* [21] reported the Urbach energy is dependent on anneal condition for sol-gel TiO₂, and the energy of 140 meV for the anatase-TiO₂ annealed in vacuum and about 100 meV for anatase/rutile mixed TiO₂. They concluded such increase of the Urbach energy is come from oxygen-vacancies or structural disordering at interface with different crystal phases. In this work, Urbach energy for the TiO₂/H₂ was higher than that for the TiO₂/O₂, however, the density of oxygen-vacancy was similar for the both layers as shown by the absorption intensity around 3.0 eV in **Figure 4(a)**. In contrast, from the result that the absorption around 2.2 eV was increased in the intensity for the TiO₂/H₂, it can be suggested not only the oxygen-vacancy but also the Ti³⁺-related defects and/or the complexes contributed the band gap narrowing.

3.3. Temperature Dependence of Resistivity

Figure 5(a) shows dependence of resistivity evaluated by VDP method for TiO_2/H_2 layer. The electrodes using Indium-dots were ohmic at overall temperatures as shown in **Figure 5(b)**, in which the current-voltage characteristics at 10 K (open-circle) and 300 K (solid-circle) are plotted. The saturated feature at low temperature indicated the layer was degenerated by the high density of conduction electron originated from shallow donors. In contrast, the resistivity was exponentially decreased with increasing temperature above 100K in Arrhenius relationship with the activation energy of 96.1 meV. Since it is difficult to attribute the activation energy to donor-level energy below conduction-band minimum in the degenerated semiconductor, influence in the grain boundary region should be taken into account in the electric conduction of the layer. In the grain boundary region, it is easy to consider deep level defects are formed by significantly disordered structures. The defects in the boundary region trap the carriers or compensate the shallow donors. In the case that the carriers are traps in the deep defects, depletion region is introduced toward the kernel. Previously, Blom *et al.* presented a conduction model for poly-crystalline layer consists of kernels and grain-boundaries and applied the analysis for temperature dependent conduction of ZnO layer [22]. In the model, resistivity of the layer parallel to the substrate is limited by that of grain boundaries surrounding kernel, because Schottky barrier is formed by traps in the grain-boundary because the resistivity of kernel can be expected to be much lower than that of the boundary region. Since the density of thermally emitted carrier across the barrier is increased with temperature, resistivity of the layer is decreased with temperature and then saturated to the resistivity due to the kernels at high temperature. However, the model is insufficient to the result in this work because the resistivity was saturated at low temperature. On the other, in the case that the carrier density is significantly reduced by compensation of shallow donors in the boundary region, resistivity in the region is much higher than in the kernel and dependent on the temperature. The resistivity in grain-boundary region is expected to be decreased with temperature. In this case, although resistivity of the layer limited by the resistance in grain-boundary is saturated at low temperature and reduced with temperature, the activation energy experimentally obtained by the result of **Figure 5(a)** is too large to explain the result of temperature dependent resistivity. Here, it should be noted that defects at deep level are also formed at surface. When electrons are captured by the traps at the surface, depletion region is extended in the boundary region with low carrier density from the TiO_2 surface. The depletion length can be estimated by density of the trapped electron in the surface state (N_{sse}) and effective donor density in the boundary region (N_{bd}) in the relationship of $N_{\text{bd}}/N_{\text{sse}}$. The depletion region acts to cut off carrier transport across the boundary region and the depleted length is decreased with temperature due to activation of electrons captured the traps, which is resulted in decrease of the resistivity with temperature. Details based on the model including surface treatment of the layer are in progress, but the simulated result can explain well the temperature dependent resistivity as shown by solid-line in **Figure 5(a)**. The result indicated $N_{\text{bd}}/N_{\text{sse}}$, peak energy of the surface trap below conduction band minimum, FWHM of surface trap distribution for electron energy and resistivity without the cut-off of electron transport in grain boundary is 1.8×10^{-5} , 195 meV, 136 meV and $4.2 \times 10^{-3} \Omega \text{ cm}$, respectively. The obtained parameters suggested resistivity of the kernel is much lower than the effective resistivity limited by the grain boundary.

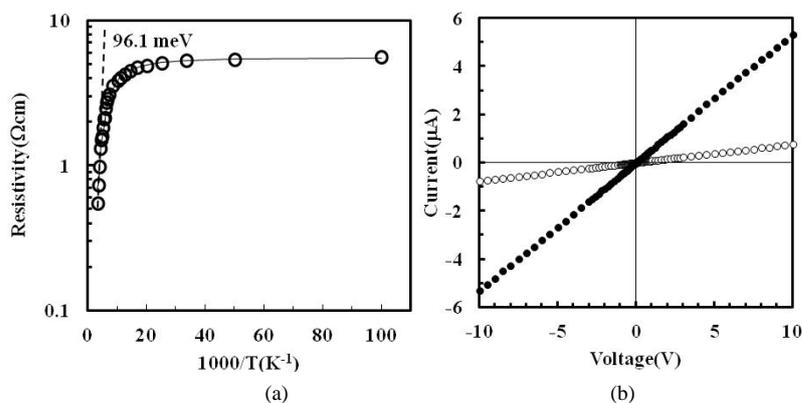


Figure 5. (a) Arrhenius plot of resistivity for TiO_2/H_2 , in which the resistivity was evaluated by VDP method and (b) I-V property of the layer at 10 K (open-circle) and 300 K (solid-circle).

4. Conclusion

Low pressure chemical vapor deposition of TiO₂ layer was performed in H₂-ambient. The deposition rate and activation energy for the deposition were decreased and decreased as compared with the deposition in O₂-ambient. Crystallographic property of the layer deposited in H₂ was inferior to that in O₂ but the resistivity was drastically reduced by using H₂ during the deposition. Optical absorption around 2.2 eV was notably increased by the deposition in H₂ with scarce increase around 3.0 eV. These results and a possible dissociation scheme of TTIP on the deposition surface suggested that donor in the layer was originated from Ti³⁺ and/or Ti³⁺-related complex, which was increased by hydrogen. Temperature dependent resistivity was also evaluated for the layer deposited in H₂, in which the resistivity was saturated at low temperature region but decreased with temperature above 100 K. A possible model consisted of kernel, grain-boundary and surface trapped electrons was applied to clarify the conduction mechanism of the layer. As a result, the temperature dependent result could be well fitted by the model and showed that electron transport in the layer was limited by depletion region in the grain-boundary. Further, the obtained parameters indicated that the grain with the resistivity of $4 \times 10^{-3} \Omega \text{ cm}$ was formed with the surface traps around 200 meV below the conduction band minimum by the demonstrated deposition process, and the boundary and the surface engineering were fundamentally necessary to perform transparent conductive TiO₂ layer.

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